

Claims 1-11 and 14-19 were pending in this case. Claim 10 has been cancelled. Claims 2, 5, 9, and 11 have been amended.

Claims 1-11 and 14-19 stand rejected under 35 U.S.C. 112, first paragraph. The rejection is based upon alleged ambiguities relating to the claim term "cavity". Applicant respectfully submits that the cavity 30 is clearly labeled in Figure 3 of the instant specification as being the region of the plate 26 bounded by channels 32. On page 7 of the instant specification in the third paragraph, the cavity is described as follows: "The cavity 30 is designed to receive the integrated circuit for seating during the testing procedure. The cavity 30 will have the same shape as the integrated circuit to be tested." As is shown in Figure 5, and as is described on page 9 of the specification, anvils 34 fit into the channels 32. Each anvil 34 is positioned to engage the pins of the integrated circuit and to maintain the pins in alignment. Applicant respectfully submits that it would be clear to one skilled in the art from these descriptions that the cavity is the space on plate 26 bounded by the channels and hence by the anvils. Thus, Applicant submits that the claim is in statutory form.

Claims 1, 2, 5, 9, 10, and 11 stand rejected under 35 U.S.C. 112, second paragraph. The Examiner appears to have mistakenly included Claim 1 in this rejection. Claim 1 does not include a reference to either Torlon® or Vespel®. Claims 2, 5, 9, and 11 have been amended in response to the rejection to remove references to trademarks. Claim 10 has been cancelled. Support for amendments to claims formerly including Torlon® or Vespel® may be found on page 7, second paragraph, of the specification where it is stated that Torlon® is a non-conductive material that is able to withstand exposure to high temperatures, and on page 9 of the specification where Torlon and Vespel are described as materials that are non-conductive, non-corrosive, and frictionless. Applicant submits that the claims are in statutory form.

Applicant respectfully requests reconsideration and withdrawal of the rejections and allowance of Claims 1-9, 11, and 14-19. If the Examiner has any questions or other correspondence regarding this application, Applicant requests that the Examiner contact Applicant's attorney at the below listed telephone number and address.

Respectfully submitted,



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**Version with Markings to Show Changes Made**

**In the Claims:**

Please amend the claims as follows:

2. (twice amended) The nest of Claim 1 wherein the plate comprises a material selected from the group consisting of aluminum, steel, or non-conductive high temperature material [Torlon®].
5. (amended) The nest of Claim 5 wherein the anvil comprises a non-conductive high temperature material [material selected from the group consisting of Torlon® and Vespel®].
9. (amended) The system of Claim 8 wherein the anvil comprises a non-conductive high temperature material [is comprised of Torlon®].
10. (cancelled)
11. (twice amended) The system of Claim 6 wherein the plate comprises a material selected from the group consisting of aluminum, steel, or non-conductive high temperature material [Torlon®].